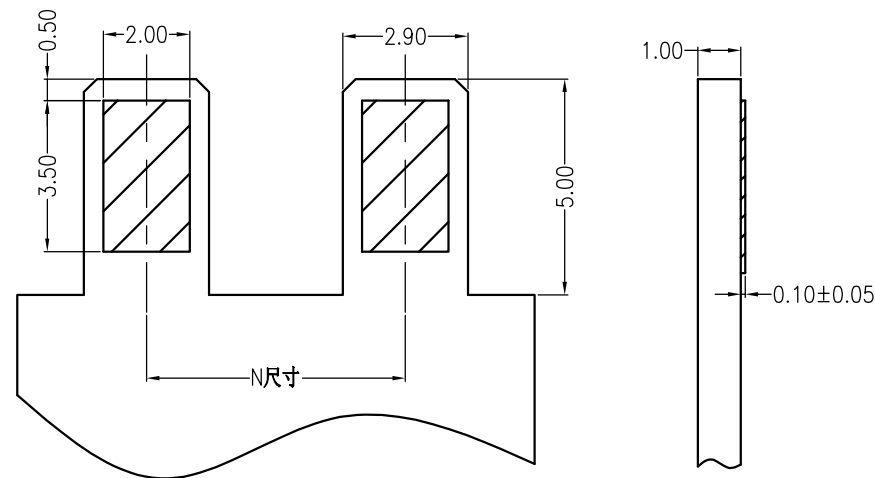
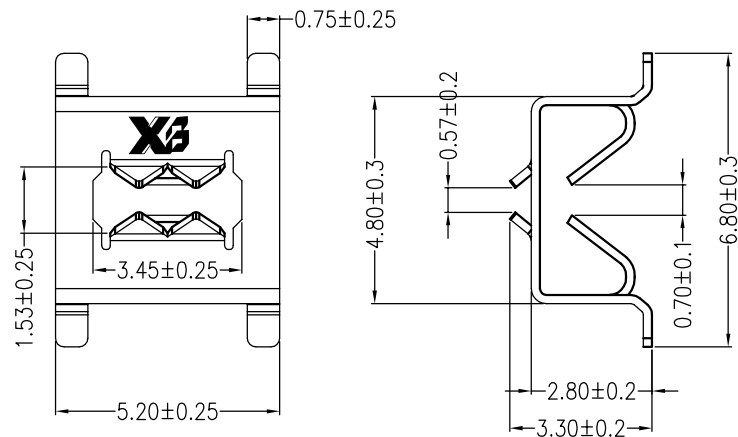
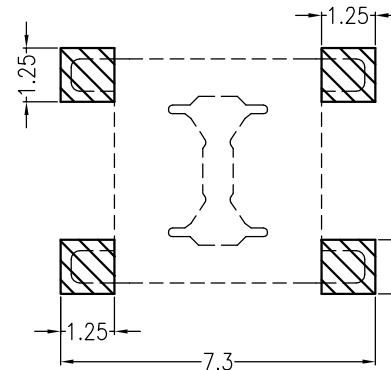
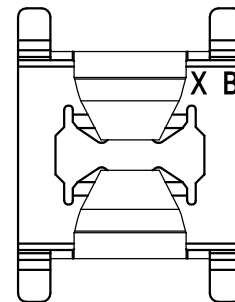


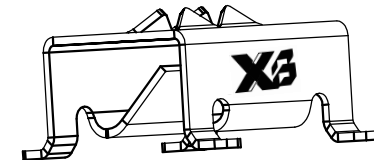
REV	ECN No.	DESCRIPTION	DESIGN	DATE
A0		Release	曾令青	2018.08.24



Mating PCB detail



Board Layout

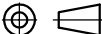


主要技术参数 Main Specifications

板 厚 (thickness): 1.0mm
 接触电阻 (Contact resistance): $\leq 20m\Omega$
 额定电压 (Rated voltage): 250 V AC DC
 额定电流 (Rated current): 1.0A AC DC
 温度范围 (Temperature Range): $-45^{\circ}C \sim +125^{\circ}C$

ORDER INFORMATION:

XB-L031C-1.0-000B1-R			
PART No.		PACKAGING:	R=REEL
No.FOR PCB:		PACKAGING:	1=PHOSPHORBRONZE
1.0mm		PLATING:	B=MATTE Sn
PLASTIC MATERIAL:			
000=No plastic parts			

C					
B					
A	CONTACT		1 PCS	PHOSPHORBRONZE	MATTE Sn-plated
ITEM	COMPONENT		Q'TY	MATERIAL	FINISH
 东莞市溪榜电子有限公司 Switch Connector DONG GUAN XI BANG ELECTRONICS CO., LTD TITLE: — —					
X.±0.5	X.±5'	USE: CUSTOMER	PART NO.:		
.X±0.3	.X±2'		L031C-1.0-000B1-R		
.XX±0.25	.XX±1'	APPD: 邵敬和	DWG NO.:		
--	--	CHKD: 田峰	GCCP-1226		
	UNITS: mm	DR: 曾令青	SCALE		SHEET
			1 : 1		1 / 1